

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : M. Mazurek et al.
Serial No. : 09/432,944
Filed : November 3, 1999
Title : PRESSURE-SENSITIVE ADHESIVES HAVING MICROSTRUCTURED SURFACES

Art Unit : 1771
Examiner : A. Singh

BOX RCE
Commissioner for Patents
Washington, D.C. 20231

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TC 1700

Amendment and Response

This communication is in response to the Final Office Action mailed on May 8, 2001.

Filed simultaneously herewith is a Request for Continued Examination under §1.114.

Claims 1-15 and 32-43 are pending. These claims have been rejected.

In the claims:

Please cancel Claim 12.

Please amend Claim 1 as follows:

1. A coated substrate comprising a substrate coated on at least one side with a continuous layer of an unfilled pressure-sensitive adhesive, the pressure sensitive adhesive having a microstructured surface, wherein the microstructured surface of the pressure-sensitive adhesive comprises a series of features, each of the features having a height of about 2.5 to about 375 micrometers, and wherein at least two of three dimensions of each feature selected from the group consisting of (i) length, (ii) width, and (iii) depth or height are microscopic, wherein "microscopic" refers to features of small enough dimensions so as to require an optic aid to the naked eye when viewed from any plane of view to determine its shape.

A "marked-up" version of the claims is added as an Appendix to this Response.

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I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

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